

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hidenobu TSUKADA</td> <td>09/24/2009</td> </tr> <tr> <td>Kouji ISHIKAWA</td> <td>09/24/2009</td> </tr> <tr> <td>Yasushi ARAI</td> <td>09/25/2009</td> </tr> <tr> <td>Shohei KAMIYA</td> <td>09/24/2009</td> </tr> </tbody> </table>		Name	Execution Date	Hidenobu TSUKADA	09/24/2009	Kouji ISHIKAWA	09/24/2009	Yasushi ARAI	09/25/2009	Shohei KAMIYA	09/24/2009
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Shohei KAMIYA	09/24/2009										
RECEIVING PARTY DATA											
Name:	HITACHI CONSTRUCTION MACHINERY CO., LTD.										
Street Address:	5-1, Koraku 2-chome, Bunkyo-ku										
City:	Tokyo										
State/Country:	JAPAN										
Postal Code:	112-0004										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12578702</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12578702						
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CORRESPONDENCE DATA											
Fax Number:	(703)684-1157										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
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Correspondent Name:	John Mattingly, Mattingly & Malur, P.C.										
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NAME OF SUBMITTER:	John R. Mattingly										
Total Attachments: 1											

CH \$40.00 12578702

500987853

**PATENT
 REEL: 023368 FRAME: 0890**

ASSIGNMENT (讓渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI CONSTRUCTION MACHINERY CO., LTD., a corporation organized under the laws of Japan, located at 5-1, Koraku 2-chome, Bunkyo-ku, Tokyo 112-0004 Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI CONSTRUCTION MACHINERY CO., LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to **EXHAUST GAS PURIFICATION SYSTEM FOR ENGINEERING MACHINE**

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI CONSTRUCTION MACHINERY CO., LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI CONSTRUCTION MACHINERY CO., LTD.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

- | | | |
|-----|---|------------------|
| 1) | <u>Hidenobu Tsukada</u>
Hidenobu TSUKADA | <u>9/24/2009</u> |
| 2) | <u>Kouji Ishikawa</u>
Kouji ISHIKAWA | <u>9/24/2009</u> |
| 3) | <u>Yasushi Arai</u>
Yasushi ARAI | <u>9/25/2009</u> |
| 4) | <u>Shohei Kamiya</u>
Shohei KAMIYA | <u>9/24/2009</u> |
| 5) | _____ | _____ |
| 6) | _____ | _____ |
| 7) | _____ | _____ |
| 8) | _____ | _____ |
| 9) | _____ | _____ |
| 10) | _____ | _____ |

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